

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6756239

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	KAIMING LUO	08/28/2020
	SARFRAZ QURESHI	08/28/2020
	MD ZAKIR ULLAH	08/28/2020
	JESSICA LOW JING WEN	08/28/2020
	HARSH NARENDRAKUMAR JAIN	08/28/2020
	KOK SIAK TANG	08/22/2020
	INDRA V. CHARY	09/04/2020
	MATTHEW J. KING	09/04/2020
RECEIVING PARTY DATA		
Name:	MICRON TECHNOLOGY, INC.	
Street Address:	8000 SOUTH FEDERAL WAY, MAILSTOP 1-507	
City:	BOISE	
State/Country:	IDAHO	
Postal Code:	83707-0006	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	17016039
CORRESPONDENCE DATA		
Fax Number:	(801)531-9168	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	8015321922	
Email:	mebriggs@traskbritt.com	
Correspondent Name:	TRASKBRITT	
Address Line 1:	230 SOUTH 500 EAST, SUITE 300	
Address Line 4:	SALT LAKE CITY, UTAH 84102	
ATTORNEY DOCKET NUMBER:	2269-15475(2020-0677.00	
NAME OF SUBMITTER:	ELIZABETH HERBST SCHIERMAN	
SIGNATURE:	/Elizabeth Herbst Schierman/	

DATE SIGNED:	06/10/2021
Total Attachments: 24 source=2021-06-10-Assignment-15475US#page1.tif source=2021-06-10-Assignment-15475US#page2.tif source=2021-06-10-Assignment-15475US#page3.tif source=2021-06-10-Assignment-15475US#page4.tif source=2021-06-10-Assignment-15475US#page5.tif source=2021-06-10-Assignment-15475US#page6.tif source=2021-06-10-Assignment-15475US#page7.tif source=2021-06-10-Assignment-15475US#page8.tif source=2021-06-10-Assignment-15475US#page9.tif source=2021-06-10-Assignment-15475US#page10.tif source=2021-06-10-Assignment-15475US#page11.tif source=2021-06-10-Assignment-15475US#page12.tif source=2021-06-10-Assignment-15475US#page13.tif source=2021-06-10-Assignment-15475US#page14.tif source=2021-06-10-Assignment-15475US#page15.tif source=2021-06-10-Assignment-15475US#page16.tif source=2021-06-10-Assignment-15475US#page17.tif source=2021-06-10-Assignment-15475US#page18.tif source=2021-06-10-Assignment-15475US#page19.tif source=2021-06-10-Assignment-15475US#page20.tif source=2021-06-10-Assignment-15475US#page21.tif source=2021-06-10-Assignment-15475US#page22.tif source=2021-06-10-Assignment-15475US#page23.tif source=2021-06-10-Assignment-15475US#page24.tif	

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, each undersigned ASSIGNOR does hereby:

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AUTHORIZE the ASSIGNEE to apply for and receive any and all United States and foreign patents relating to such improvements in its own name;

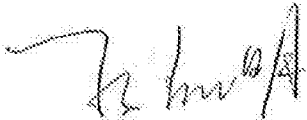
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ASSIGNOR(S):



Date: 28. Aug 2020

Kaiming Luo

Residing at: 2 Gateway Drive, #10-09, J Gateway, Singapore 608533

Date: _____

Sarfraz Qureshi

Residing at: #05-537, Block 366, Clementi Avenue 2, Singapore 120366

Date: _____

Md Zakir Ullah

Residing at: The Quintet, Block 44, #14-17, Choa Chu Kang Street 64, Singapore 689105

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Kok Siak Tang
Residing at: Blk 108C McNair Road, #03-212, Singapore 324108

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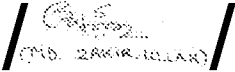
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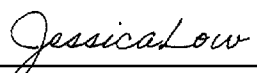
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/ Indra V. Chary /
Indra V. Chary
Residing at: 1168 E. Opus Street, Boise, ID 83716
Date: _____ / 09/04/2020 /

Matthew J. King
Residing at: 6272 North Stafford Place, Boise, ID 83713
Date: _____

**Attorney Docket No. 2269-P15475US
(2020-0677.00/US)**

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, each undersigned ASSIGNOR does hereby:

SELL, ASSIGN AND TRANSFER to MICRON TECHNOLOGY, INC. (“ASSIGNEE”), a corporation of the State of Delaware, having a place of business at 8000 South Federal Way, Mailstop 1-507, Boise, ID 83707-0006, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements that are disclosed in the **Application for United States Letters Patent** that has been executed by each undersigned ASSIGNOR concurrently herewith, and titled **MICROELECTRONIC DEVICES WITH TIERED BLOCKS SEPARATED BY PROGRESSIVELY SPACED SLITS, AND RELATED METHODS AND SYSTEMS**, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent or the legal equivalent thereof that have been or may be filed in the United States and all foreign countries relating to any of such improvements; all original, reexamined and reissued patents that have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application made in the United States;

AUTHORIZE the ASSIGNEE to apply for and receive any and all United States and foreign patents relating to such improvements in its own name;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to and in the name of the ASSIGNEE;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement or encumbrance affecting the rights and property herein conveyed has been or will be made or entered into by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, to execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications relating to any and all such improvements; to execute all rightful oaths, declarations, assignments, powers of attorney and other papers; to communicate to the ASSIGNEE all facts and provide to the ASSIGNEE all documents and things known and accessible to the undersigned relating to such improvements and the history thereof, and testify as to the same in any interference, litigation or other proceeding relating thereto; and generally to do everything possible that the ASSIGNEE shall consider desirable for vesting title to such improvements in the ASSIGNEE, and to secure, maintain, defend and enforce valid and enforceable patent protection for such improvements;

AGREE AND ACKNOWLEDGE that the SALE, ASSIGNMENT AND TRANSFER of rights and property set forth herein is and shall be IRREVOCABLE and BINDING upon the heirs, assigns, representatives and successors of each undersigned ASSIGNOR and EXTEND to the successors, assigns and nominees of the ASSIGNEE.

ASSIGNOR(S):

Kaiming Luo
Residing at: 2 Gateway Drive, #10-09, J Gateway, Singapore 608533
Date: _____

Sarfraz Qureshi
Residing at: #05-537, Block 366, Clementi Avenue 2, Singapore 120366
Date: _____

Md Zakir Ullah
Residing at: The Quintet, Block 44, #14-17, Choa Chu Kang Street 64, Singapore 689105
Date: _____

Jessica Low Jing Wen
Residing at: 46 Choa Chu Kang Street 64, #18-21, Singapore 689106
Date: _____

Harsh Narendrakumar Jain
Residing at: 3555 N Cole Rd., Apt 306, Boise, ID 83704
Date: _____

Kok Siak Tang
Residing at: Blk 108C McNair Road, #03-212, Singapore 324108

Date: _____

Indra V. Chary
Residing at: 1168 E. Opus Street, Boise, ID 83716

Date: _____

/Matthew J King/
Matthew J. King
Residing at: 6272 North Stafford Place, Boise, ID 83713

Date: 9/4/2020_____